## **DECLARATION - USA PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled Variable Magnetic Shield For Integrated Circuit Packaging; the specification of which is attached hereto;

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56;

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: Mark E. Tuttle

Inventor's signature Men 2

Date 1-4-02

Residence: 1998 Table Rock Road, Boise, ID 83712

Citizenship: U.S.

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F	'nII	name	of	second	inventor:	.1	[ames	G	Deak
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Inventor's signature

Date 1/04/02

Residence: 7231 West Colonial Street, A301, Boise, ID 83709

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Send Correspondence To: KNOBBE, MARTENS, OLSON & BEAR, LLP Customer No. 20,995

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	:	Tuttle et al.	)
App. No.	:	Unknown	)
Filed	:	Herewith	)
For	:	METHODS AND STRUCTURES FOR REDUCED PARASITIC CAPACITANCE IN INTEGRATED CIRCUIT METALLIZATIONS	)
Examiner	:	Unknown	)

## ESTABLISHMENT OF RIGHT OF ASSIGNEE TO TAKE ACTION AND REVOCATION AND POWER OF ATTORNEY

Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir:

The undersigned is empowered to act on behalf of the assignee below (the "Assignee"). A true copy of the original Assignment of the above-captioned application from the inventor to the Assignee is attached hereto. This Assignment represents the entire chain of title of this invention from the Inventor to the Assignee.

I declare that all statements made herein are true, and that all statements made upon information and belief are believed to be true, and further, that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that willful, false statements may jeopardize the validity of the application, or any patent issuing thereon.

The undersigned hereby revokes any previous powers of attorney in the subject application, and hereby appoints the registrants of Knobbe, Martens, Olson & Bear, LLP, 620 Newport Center Drive, Sixteenth Floor, Newport Beach, California 92660, Telephone

App. No. : Un vn Filed : Herewith

(949) 760-0404, Customer No. 20,995, and Michael L. Lynch, Reg. No. 30,871, Micron Technology, Inc., 8000 South Federal Way, Boise, Idaho 83707-0006, as its attorneys with full power of substitution and revocation to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected herewith. This appointment is to be to the exclusion of the inventor and his attorneys in accordance with the provisions of 37 C.F.R. § 3.71.

Please use Customer No. 20,995 for all communications.

Micron Technology, Inc.

Dated: /-14-2002

Michael L. Lynch

Title: Chief Patent Counsel

Address: 8000 South Federal Way Boise, ID 83707-0006

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